

# GSMDC2604Z

## 20V N-Channel MOSFETs

### Product Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are well suited for high efficiency fast switching applications.

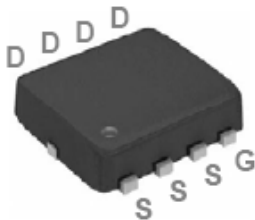
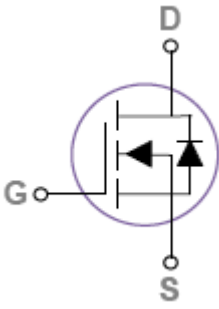
### Features

- 20V, 80A,  $R_{DS(ON)}=3.5m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS guaranteed
- Green Device Available
- DFN3X3-8L package design

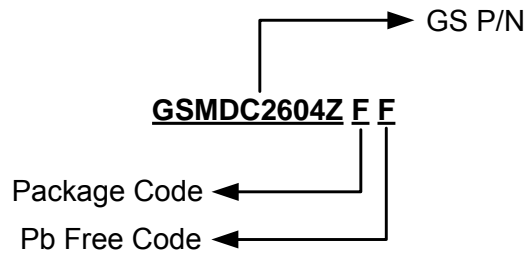
### Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2<sup>nd</sup> SR

### Packages & Pin Assignments

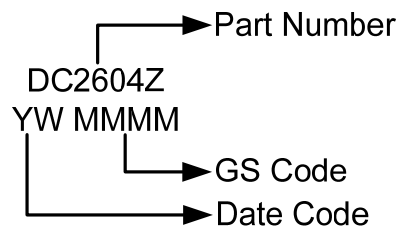
GSMDC2604ZFF (DFN3X3-8L)	
 <p>Top View</p>	
	
Pin	Description
1	Source
2	Source
3	Source
4	Gate
5	Drain
6	Drain
7	Drain
8	Drain

## Ordering Information



Part Number	Package	Quantity
GSMDC2604ZFF	DFN3X3-8L	3000 PCS

## Marking Information



## Absolute Maximum Ratings

$T_C=25^{\circ}\text{C}$  Unless otherwise noted

Symbol	Parameter	Typical	Unit
$V_{DS}$	Drain-Source Voltage	20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D$	Continuous Drain Current (Chip Limitation)	$T_C=25^{\circ}\text{C}$	80
		$T_C=100^{\circ}\text{C}$	51
$I_{DM}$	Pulsed Drain Current	320	A
$P_D$	Power Dissipation ( $T_C=25^{\circ}\text{C}$ )	66	W
	Power Dissipation (Derate above $25^{\circ}\text{C}$ )	0.53	W/ $^{\circ}\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to +175	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to +175	$^{\circ}\text{C}$
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance-Junction to Case	2	$^{\circ}\text{C}/\text{W}$

## Electrical Characteristics

T<sub>J</sub>=25°C Unless otherwise noted

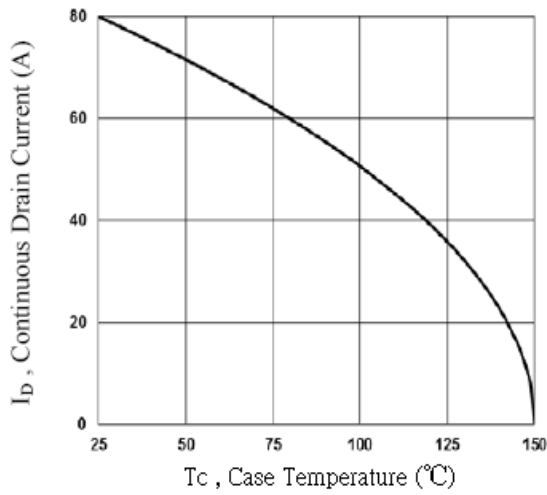
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	20			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	0.3	0.65	1	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> =16V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			10	
I <sub>S</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current			80	A
I <sub>SM</sub>	Pulsed Source Current				160	
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A		2.8	3.5	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =10A		3.5	4.5	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =6A		5	7	
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =5A		35		S
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =1A			1	V
<b>Dynamic</b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A		52	100	nC
Q <sub>gs</sub>	Gate-Source Charge			6.6	12	
Q <sub>gd</sub>	Gate-Drain Charge			13.8	28	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1MHz		3870	5500	pF
C <sub>oss</sub>	Output Capacitance			580	850	
C <sub>rss</sub>	Reverse Transfer Capacitance			340	600	
t <sub>d(on)</sub>	Turn-On Time	V <sub>DD</sub> =10V, I <sub>D</sub> =1A, V <sub>GS</sub> =4.5V, R <sub>G</sub> =3.3Ω		20.2	40	ns
t <sub>r</sub>				31.2	60	
t <sub>d(off)</sub>	Turn-Off Time			68.5	120	
t <sub>f</sub>				21.2	42	
R <sub>g</sub>	Gate Resistance		V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		1.3	

Note 1: Repetitive Rating : Pulsed width limited by maximum junction temperature.

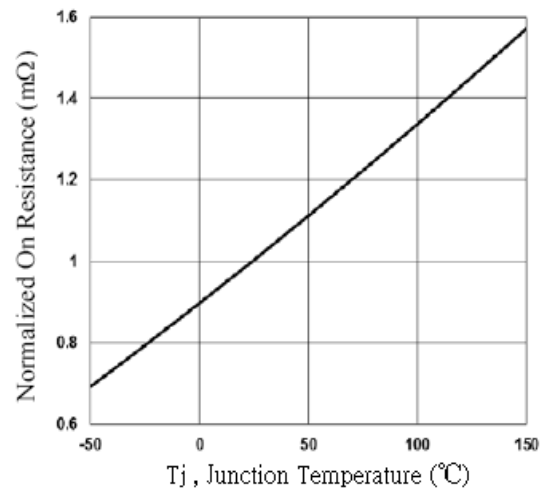
Note 2: The data tested by pulsed , pulse width ≤300us, duty cycle ≤2%.

Note 3: Essentially independent of operating temperature.

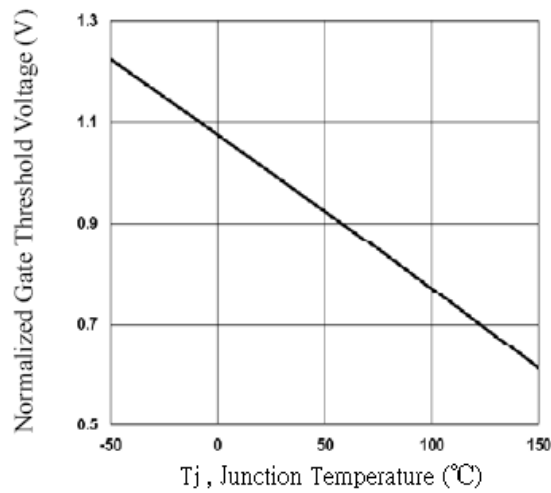
## Typical Performance Characteristics



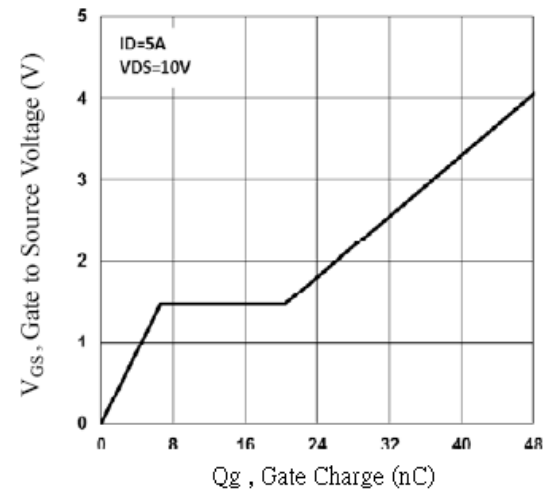
**Fig.1 Continuous Drain Current vs.  $T_c$**



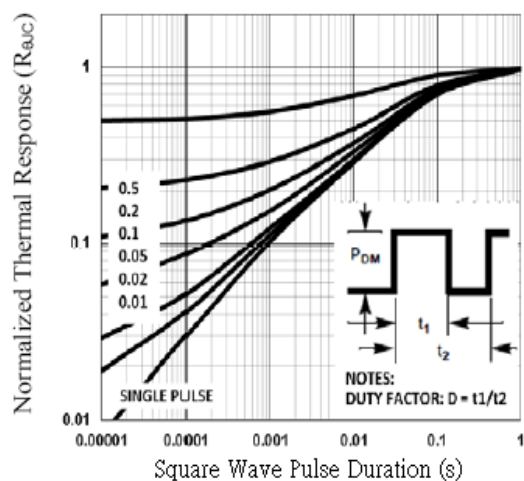
**Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_j$**



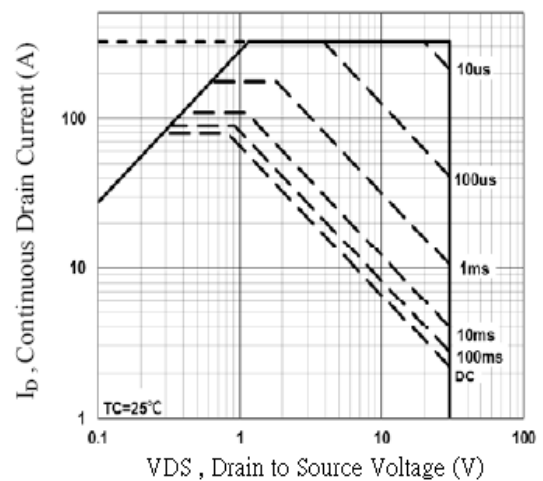
**Fig.3 Normalized  $V_{th}$  vs.  $T_j$**



**Fig.4 Gate Charge Waveform**



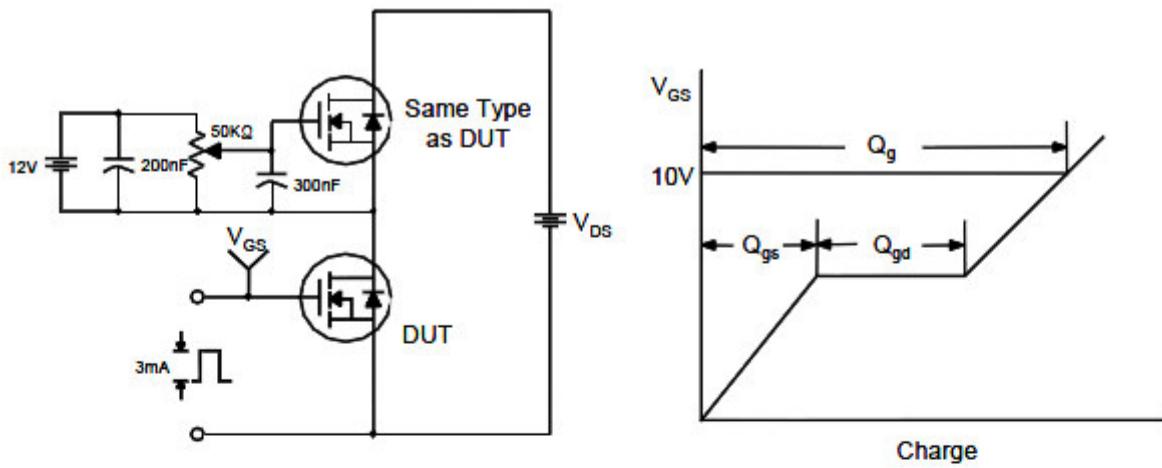
**Fig.5 Normalized Transient Impedance**



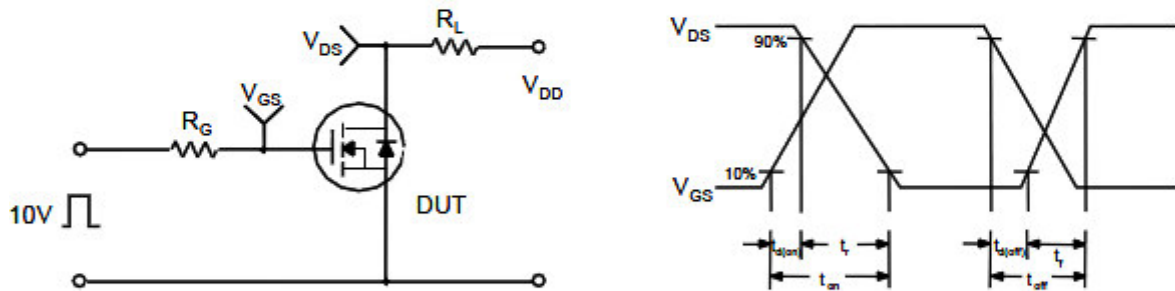
**Fig.6 Maximum Safe Operation Area**

## Typical Performance Characteristics (Continue)

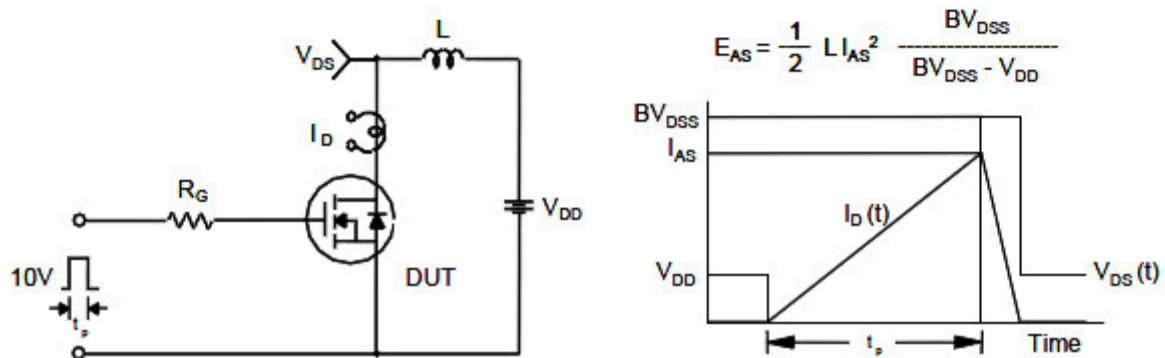
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

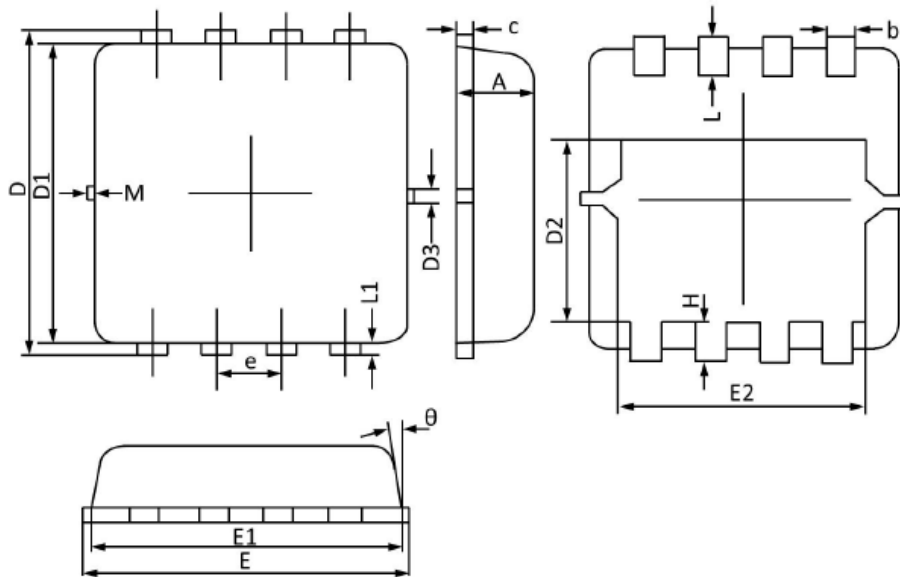


Unclamped Inductive Switching Test Circuit & Waveforms



## Package Dimension

### DFN3X3-8L







### Dimensions




Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
b	0.250	0.350	0.010	0.013
c	0.100	0.250	0.004	0.009
D	3.250	3.450	0.128	0.135
D1	3.000	3.200	0.119	0.125
D2	1.780	1.980	0.070	0.077
D3	0.130 (REF)		0.005 (REF)	
E	3.200	3.400	0.126	0.133
E1	3.000	3.200	0.119	0.125
E2	2.390	2.590	0.094	0.102
e	0.650 (BSC)		0.026 (BSC)	
H	0.300	0.500	0.011	0.019
L	0.300	0.500	0.011	0.019
L1	0.130 (REF)		0.005 (REF)	
θ	0°	12°	0°	12°
M	0.150 (REF)		0.006 (REF)	



## NOTICE

Information furnished is believed to be accurate and reliable. However Globaltech Semiconductor assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Globaltech Semiconductor. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information without express written approval of Globaltech Semiconductor.

## CONTACT US

GS Headquarter	
	4F.,No.43-1,Lane11,Sec.6,Minquan E.Rd NeiHu District Taipei City 114, Taiwan (R.O.C)
	886-2-2657-9980
	886-2-2657-3630
	sales_twn@gs-power.com

Shenzhen Branch(China)	
	1113 B Building, Happiness Washington, Baoan Nan Road, Luohu District, Shenzhen City, China
	0755-22208941
	sales_cn@gs-power.com

RD Division	
	824 Bolton Drive Milpitas. CA. 95035
	1-408-457-0587